



BAV199DW

QUAD SURFACE MOUNT LOW LEAKAGE DIODE

Features

- Surface Mount Package Ideally Suited for Automated Insertion
- Very Low Leakage Current
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

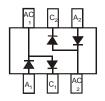
Mechanical Data

- Case: SOT363
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 (3)
- Polarity: See Diagram
- Weight: 0.008 grams (Approximate)

SOT363







Top View Internal Schematic

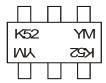
Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
BAV199DW-7-F	Standard	SOT363	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



K52 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: C = 2015) M = Month (ex: 9 = September)

Date Code Key

	Year	2006	2007	2008		2	2015	2016	2017	201	8	2019	2020
	Code	Т	U	V			С	D	Е	F		G	Н
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Monti	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _R WM	85	V
RMS Reverse Voltage	V _{R(RMS)}	60	V	
Forward Continuous Current (Note 5)	Single Diode Double Diode	I _{FM}	160 140	mA
Repetitive Peak Forward Current (Note 5)	I _{FRM}	500	mA	
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0ms @ t = 1.0s	I _{FSM}	4.0 1.0 0.5	А

Thermal Characteristics

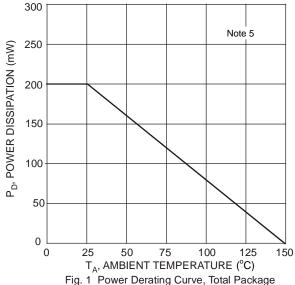
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_{D}	200	mW
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{ hetaJA}$	625	°C/W
Operating and Storage Temperature Range	T_J , T_{STG}	-65 to +150	°C

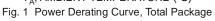
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

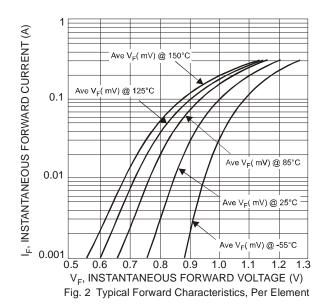
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	85	_	_	V	$I_R = 100 \mu A$
Forward Voltage	V _F	_	_	0.90 1.0 1.1 1.25	V	I _F = 1.0mA I _F = 10mA I _F = 50mA I _F = 150mA
Leakage Current (Note 6)	I _R		_	5.0 80	nA	V _R = 75V V _R = 75V, T _J = +150°C
Total Capacitance	C _T	_	1.5	_	pF	$V_R = 0, f = 1.0MHz$
Reverse Recovery Time	t _{RR}		_	3.0	μS	$I_F = I_R = 10 \text{mA},$ $I_{RR} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

Notes:

- 5. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com.
- 6. Short duration pulse test used to minimize self-heating effect.









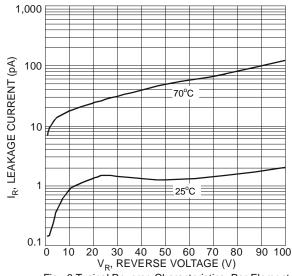
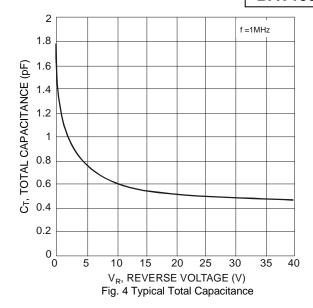
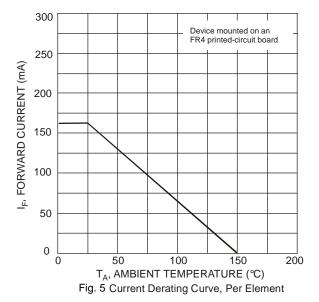


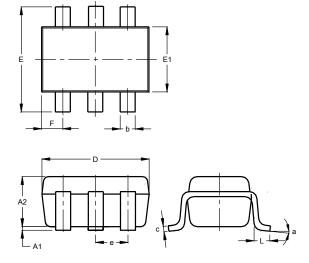
Fig. 3 Typical Reverse Characteristics, Per Element





Package Outline Dimensions

Please see AP02001 at http://www.diodes.com/_files/datasheets/ap02001.pdf for the latest version.

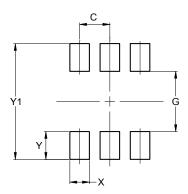


	SC	T363						
Dim	Min	Max	Тур					
A1	0.00	0.10	0.05					
A2	0.90	1.00	1.00					
b	0.10	0.30	0.25					
С	0.10	0.22	0.11					
D	1.80	2.20	2.15					
Е	2.00	2.20	2.10					
E1	1.15	1.35	1.30					
e).650 B	SC					
F	0.40	0.45	0.425					
L	0.25	0.40	0.30					
а	a 8°							
All	Dimen	sions	in mm					



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/_files/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.650
G	1.300
Х	0.420
Y	0.600
Y1	2.500

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